

Product specifications contained herein may be changed without prior notice. It is therefore advisable to contact Purdy Electronics before proceeding with the design of equipment incorporating this product.

# AND4BC

# InGaN Ultra Bright Blue Chip LEDs

#### **Features**

- Package in 8mm tape on 7: dia. reel
- Compatible with automatic placement equipment
- Suitable for infrared and vapor phase reflow solder process
- · Mono-color type
- Suitable for automotive backlighting, Flat backlighting for LDC, switch and symbol, indicator and backlighting for telecommunication use
   RoHS Compliant

## Maximum Ratings $(T_a = 25^{\circ}C)$

Characteristics	Symbol	Rating	Unit	
Forward Current	I <sub>F</sub>	30	mA	
Reverse Voltage	V <sub>R</sub>	5	V	
Power Dissipation	P <sub>D</sub>	120	mW	
Operating Temp. Range	T <sub>Opr</sub>	-40 to 80	°C	
Storage Temp. Range	T <sub>Stg</sub>	-40 to 90	°C	

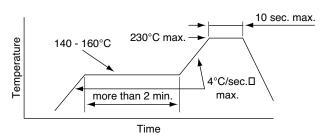
## Electro-Optical Characteristics (T<sub>a</sub> = 25°C)

Characteristics	Symbol	Test Condition	Minimum	Typical	Maximum	Unit
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> = 20 mA	_	3.5	4.3	V
Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 5 V	_	_	50	μΑ
Luminous Intensity	I <sub>V</sub>	I <sub>F</sub> = 20 mA	30	50	_	mcd
Peak Emission Wavelength	l <sub>P</sub>	I <sub>F</sub> = 20 mA	_	468	_	nm
Spectral Line Half Width	ΔΙ	I <sub>F</sub> = 20 mA	_	35	_	nm
Dominant Wavelength	ld	I <sub>F</sub> = 20 mA	-	470	_	nm
Full Viewing Angle	2 q 1/2	I <sub>F</sub> = 20 mA	_	140	_	degree

#### Precaution

Please be careful of the following:

- Manual soldering: maximum temperature of iron tip: 260°C max.
  Soldering time: within 5 sec. per solder-land
  Soldering portion of lead: up to 1.6 mm from the body of the device
- 2. Reflow solder: recommended condition is as follows:



 Absolute secure counter measures against static electricity and surge should be taken when handling these products. It is recommended to use wrist band or antistatic gloves when handling these LEDs.

For reflow soldering

